



FDD6670A

30V N-Channel PowerTrench® MOSFET

General Description

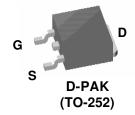
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $P_{\!\!\!\mathrm{DS}(ON)}$, fast switching speed and extremely low $P_{\!\!\!\mathrm{DS}(ON)}$ in a small package.

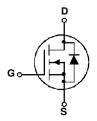
Applications

- DC/DC converter
- Motor Drives

Features

- 66 A, 30 V $R_{DS(ON)} = 8 \ m\Omega \ @ \ V_{GS} = 10 \ V$ $R_{DS(ON)} = 10 \ m\Omega \ @ \ V_{GS} = 4.5 \ V$
- Low gate charge
- Fast Switching
- High performance trench technology for extremely low $P_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage			30	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Continuous Drain Current	@T _C =25°C	(Note 3)	66	Α
		@T _A =25°C	(Note 1a)	15	
		Pulsed	(Note 1a)	100	
P _D	Power Dissipation	@T _C =25°C	(Note 3)	63	W
		@T _A =25°C	(Note 1a)	3.2	
		@T _A =25°C	(Note 1b)	1.3	
T_J , T_{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C

Thermal Characteristics

R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	2.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
$R_{\theta JA}$		(Note 1b)	96	

Package Marking and Ordering Information

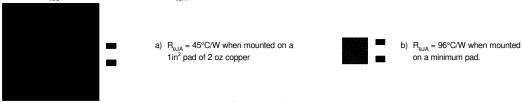
		3				
Device Marking Device		Package	Reel Size	Tape width	Quantity	
	FDD6670A	FDD6670A	D-PAK (TO-252)	13"	16mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-Sc	ource Avalanche Ratings (Not	te 2)				
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_{D} = 66 \text{ A}$			67	mJ
I _{AS}	Drain-Source Avalanche Current				66	Α
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		26		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1	1.8	3	V
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		- 5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		6.3 7.9 9.5	8 10 13	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 15 \text{ A}$		60		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1755		рF
Coss	Output Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$		430		рF
C _{rss}	Reverse Transfer Capacitance	1 = 1.0 MH2		180		рF
R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.3		Ω
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Turn-On Rise Time	$V_{DD} = 15 \text{ V}, \qquad I_{D} = 1 \text{ A},$		12	21	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		29	47	ns
t _f	Turn-Off Fall Time			19	34	ns
Q _g	Total Gate Charge			16	22	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 15V, I_{D} = 15 A,$ $V_{GS} = 5 V$		4.6		nC
Q_{gd}	Gate-Drain Charge	VGS - V		6.2		nC

Electrical Characteristics $T_{A} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	rest Conditions	IVIIN	тур	wax	Units	
Drain-Source Diode Characteristics and Maximum Ratings							
Is	Maximum Continuous Drain-Source D	Diode Forward Current			2.3	Α	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_{\text{S}} = 2.3 \text{ A} \text{(Note 2)}$		0.74	1.2	V	
t _{rr}	Diode Reverse Recovery Time	$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$		28		ns	
Q_{rr}	Diode Reverse Recovery Charge			18		nC	

1. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteed by design while R_{BCA} is determined by the user's board design.



Scale 1:1 on letter size paper

on a minimum pad.

- 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%
- 3. Maximum current is calculated as:

where P_D is maximum power dissipation at T_C = 25°C and $R_{DS(on)}$ is at $T_{J(max)}$ and V_{GS} = 10V. Package current limitation is 21A

Typical Characteristics

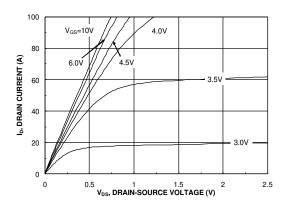


Figure 1. On-Region Characteristics

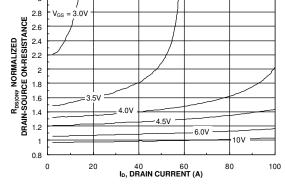


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

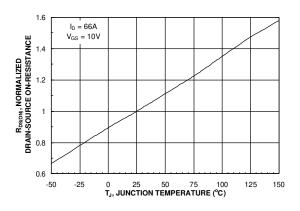


Figure 3. On-Resistance Variation withTemperature

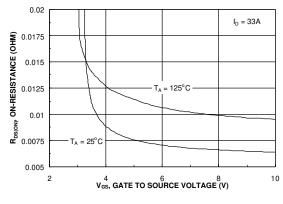


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

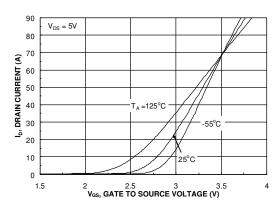


Figure 5. Transfer Characteristics

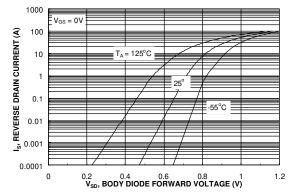
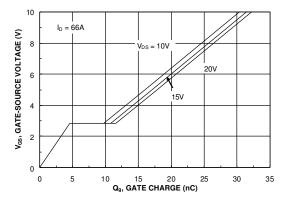


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Characteristics



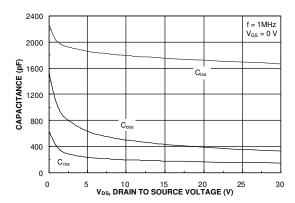
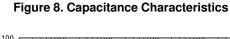
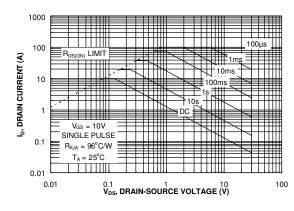


Figure 7. Gate Charge Characteristics





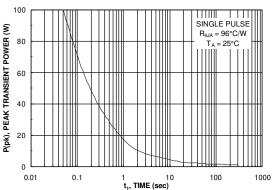


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation

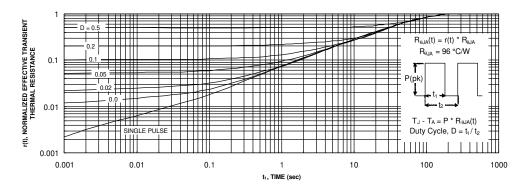
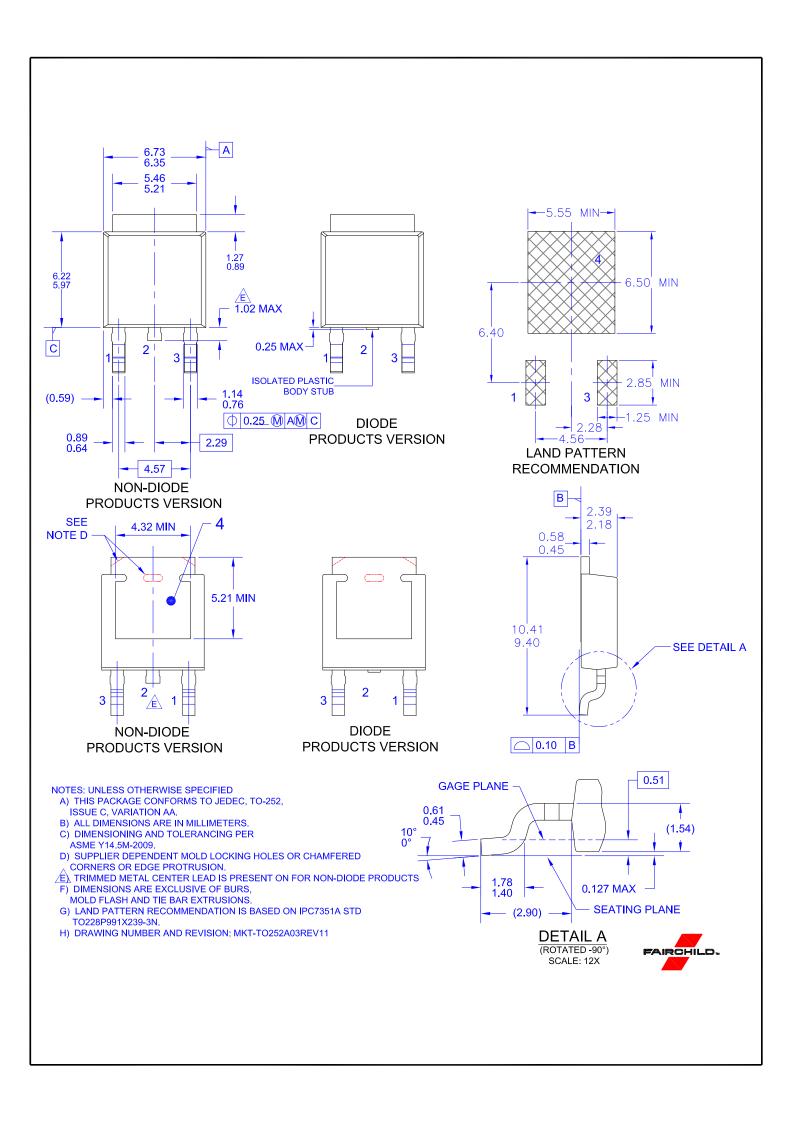


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.







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Definition of Terms					
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Rev. 177